	e standard	-			Storage					
	Temperature range Operating Humidity range		-55 °C to +105°C (Note1) Ter 20% to 80% Sto Hu		Tempera	Temperature range Storage Humidity range		-10 °C to +60°C (Note2) 40% to 70% (Note2)		
Rating					Humidity					
	Voltage		250 V AC/E	DC	UL C-UL _Rating	Volt	age	29.9 V AC/DC		
	Current Applicable Connector		AWG 20 : 4 A/pin AWG 2 AWG 24 : 2 A/pin AWG 2	AWG 20 : 4 A/pin AWG 22 : 3A/pin AWG 24 : 2 A/pin AWG 26 : 1 A/pin		Current Operating temperature range		4A/pin -55 °C to +75°C (Note1)		
			DF62W-9S-2.2C(##)							
			Spe	cificat	ions					
	tem		Test method				Re	quirements	QT	А
Construct	ion									
General examination		Visually a	Visually and by measuring instrument.				According to drawing.			
Marking		Confirme	Confirmed visually.			T X				>
Electric o	characteris	stics								1
Contact resistance		20mV N	20mV MAX, 1mA (DC or 1000Hz).				30 mΩ MAX.			-
Insulation resistance		500 V DO	500 V DC.				1000 MΩ MIN.			-
Voltage pro	of	650 V AC for 1 min.				No flashover or breakdown.			Х	-
Mechani	cal charad	cteristics								I
Vechanical			insertion and extraction.		,			e: 30 mΩ MAX. k or looseness of parts.	X	-
Vibration		Frequenc	cy 10 to 55 Hz, single ampliti	ude			-	ontinuity of 1 μ s.	X –	
			0.75 mm, at 10 cycles for 3 direction. 490 m/s ² duration of pulse 11 ms at 3 times each for				2)No damage, crack or looseness of parts.			
Shock			duration of pulse 11 ms at 3 ial directions.	3 times eac	h for				Х	-
Mating force		Measure	Measured by applicable connector.			Insertion force : 33.7 N MAX Extraction force : 1.75 N MIN			Х	-
Lock streng	th	Measure	d by applicable connector.		30	N MI	Ν		Х	-
	ental chara									
Damp heat (Steady state)			Exposed at $40 \pm 2^{\circ}$ C , 90 to 95 %, 96 h. (After leaving the room temperature for 1 to 2h.)			 Contact resistance: 30 m Ω MAX. Insulation resistance: 500 M Ω Min. No damage, crack or looseness of parts. 				-
Rapid change of temperature		Time Under 5 d (The tran	Temperature $-55^{\circ}C \rightarrow +105^{\circ}C$ Time $30min \rightarrow 30min$ Under 5 cycles.(The transferring time of the tank is 2 to 3 min)(After leaving the room temperature for 1 to 2h.)			1)Contact resistance: 30 mΩ MAX. X 2)Insulation resistance: 1000 MΩ Min. 3)No damage, crack or looseness of parts.			X	-
Dry heat		Exposed	at +105°C,96h.	,					Х	-
Cold		Exposed	at -55°C,96h.						Х	-
Note 2: Apply		n of long term	urrent. storage for unused products bel mperature and humidity range is			age d	luring transpo	rtation.		
Cour	nt	Descript	ion of revisions		Designed	gned		Checked		ate
2 1	DIS-H-00006308			HT. S				SZ. ONO	2020	090
Jnless oth	erwise spec	cified, refer	to IEC 60512.				Approved	HS. OKAWA	2018	022
						Ĺ	Checked	TS. FUKUSHIMA	2018	
						Ļ	Designed	HT. SATO	2018	
							Drawn	SN. MIWA	2018	
	Qualification T	lification Test AT:Assurance Test X:Applicable Tes			Drawin)
RS		Speci	ification sheet P		Part No.		DF62WZ-9P-2. 2DSA (20)			
				1		1				

Code No.

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<u>⁄</u>2

CL544-1050-0-20

FORM HD0011-2-1

HIROSE ELECTRIC CO., LTD.

Specifications											
Item	Test method	Requirements	QT	AT							
Resistance to Soldering heat	 Solder bath method Soldered at solder temperature 260°c for in immersion, duration, 10 s. Manual soldering Soldering iron temperature:300°C, Soldering time: 3s. No strength on contact. 	Such as impaired function ,no deformation of case of excessive looseness of the terminals.	X	-							
Solderability	Soldered at solder temperature 245°C for in immersing duration 5s.	A new uniform coating of solder shall cover minimum of 95% of the surface being immersed.	Х	-							
Sealing	Exposed at a depth of 1m for 0.5h.	No water penetration inside connector.	Х	-							

FORM HD0011-2-1